



# 35FS4500, 35FS6500

Grade 0 safety power system basis chip with CAN flexible data transceiver

Rev. 1.0 — 15 December 2017

Short data sheet: advance information

## 1 General description

The 35FS4500/35FS6500 SMARTMOS devices are a multi-output, power supply, integrated circuit, including CAN Flexible Data (FD) transceiver, dedicated to harsh automotive and transportation markets requiring high reliability (Grade 0) and high functional safety (fit for ASIL D) performance.

Multiple switching and linear voltage regulators, including low-power mode (32  $\mu$ A) are available with various wake-up capabilities. An advanced power management scheme is implemented to maintain high efficiency over a wide range of input voltages (down to 2.7 V) and output current ranges (up to 1.5 A).

The 35FS4500/35FS6500 includes configurable fail-safe/fail silent safety behavior and features, with two fail-safe outputs, becoming a full part of a safety oriented system partitioning, to reach a high integrity safety level (up to ASIL D).

The built-in CAN FD interface fulfills the ISO 11898-2 and -5 standards.

High temperature capability up to  $T_A = 150\text{ }^{\circ}\text{C}$  and  $T_J = 175\text{ }^{\circ}\text{C}$ , compliant with AEC-Q100 Grade 0 automotive qualification.

## 2 Features

- Battery voltage sensing and MUX output pin
- Highly flexible SMPS pre-regulator, allowing two topologies: non-inverting buck-boost and standard buck
- 36 V maximum input operating voltage
- Family of devices to supply MCU core from 1.0 V to 5.0 V, with SMPS (0.8 A or 1.5 A) or LDO (0.5 A)
- Linear voltage regulator dedicated to auxiliary functions, or to sensor supply ( $V_{CCA}$  tracker or independent), 5.0 V or 3.3 V
- Linear voltage regulator dedicated to MCU A/D reference voltage or I/Os supply ( $V_{CCA}$ ), 5.0 V or 3.3 V
- 3.3 V keep alive memory supply available in low-power mode
- Long duration timer, counting up to 6 months with 1.0 s resolution
- Multiple wake-up sources in low-power mode: CAN, I/Os, LDT
- Five configurable I/Os

## 3 Applications

- $T_A$  up to  $150\text{ }^{\circ}\text{C}$  and  $T_J$  up to  $175\text{ }^{\circ}\text{C}$
- Drive train electrification (BMS, hybrid EV and HEV, inverter, DCDC, alternator starter)
- Drive train - chassis and safety (active suspension, steering, safety domain gateway)
- Power train (EMS, TCU, gear box)



4 Simplified application diagram

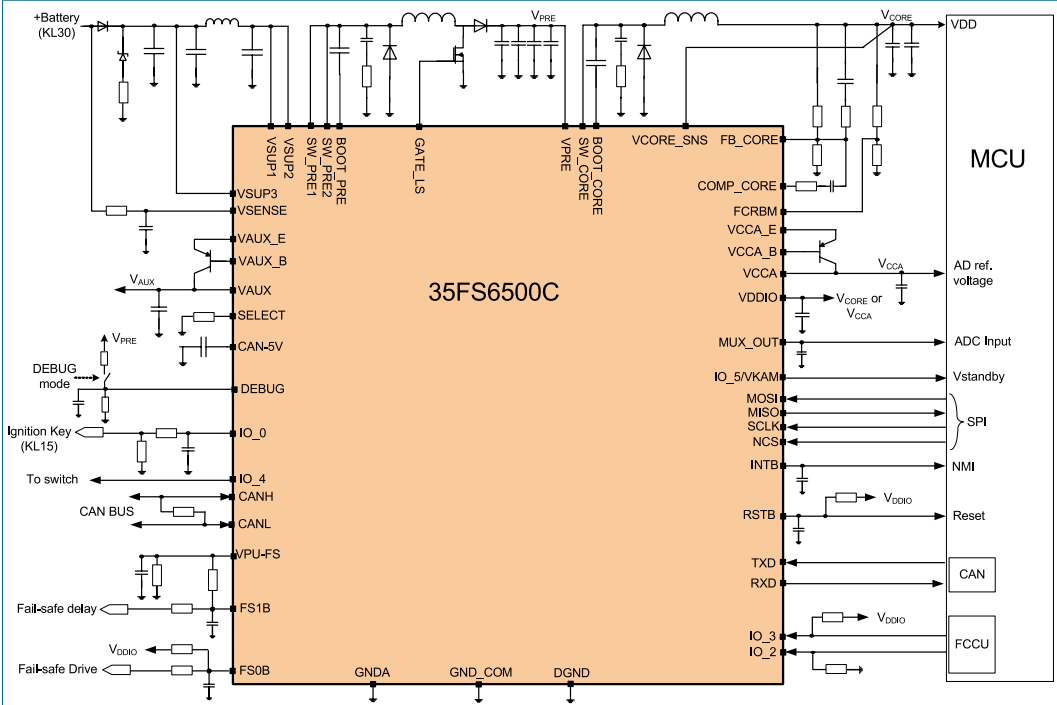


Figure 1. 35FS6500C simplified application diagram - buck boost configuration - FS1B

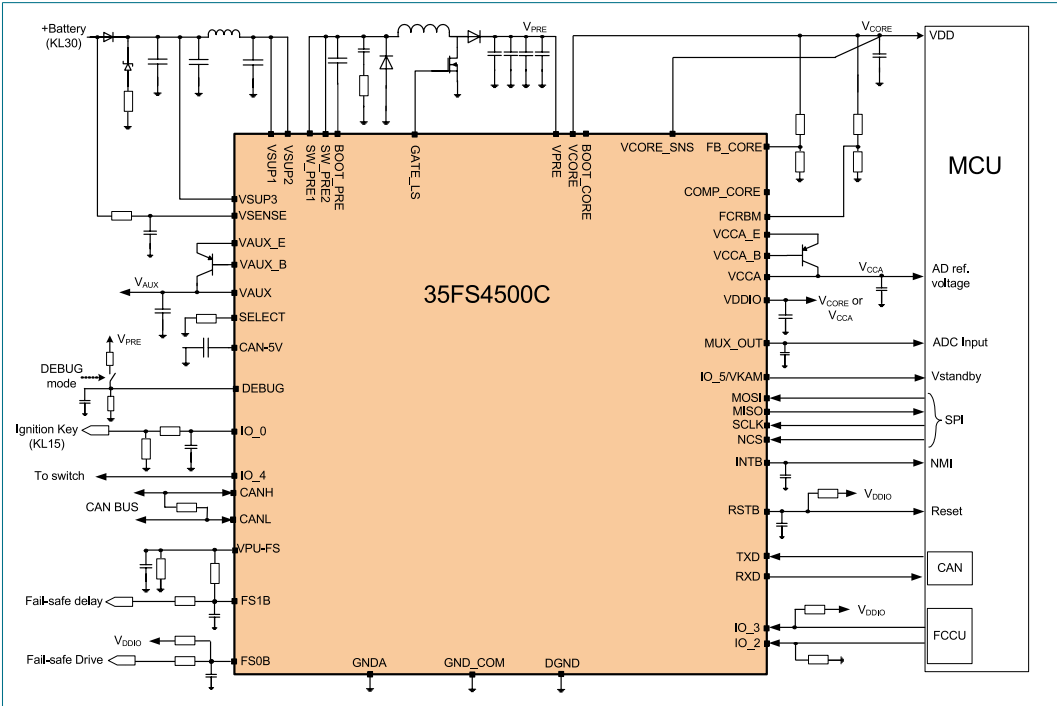


Figure 2. 35FS4500C simplified application diagram - buck boost configuration - FS1B

## 5 Ordering information

### 5.1 Part numbers definition

**MC35FS c 5 x y z AE/R2**

**Table 1. Part number breakdown**

| Code | Option   | Variable                  | Description    |
|------|----------|---------------------------|----------------|
| c    | 4 series | V <sub>CORE</sub> type    | Linear         |
|      | 6 series |                           | DCDC           |
| x    | 0        | V <sub>CORE</sub> current | 0.5 A or 0.8 A |
|      | 1        |                           | 1.5 A          |
| y    | 0        | Functions                 | none           |
|      | 1        |                           | FS1B           |
|      | 2        |                           | LDT            |
|      | 3        |                           | FS1B, LDT      |
| z    | N        | Physical interface        | none           |
|      | C        |                           | CAN FD         |

### 5.2 Part numbers list

**Table 2. Orderable part variations**

| Part number   | Temperature (T <sub>A</sub> ) | Package                 | FS1B | LDT | V <sub>CORE</sub> | V <sub>CORE</sub> type | VKAM on | CAN FD | Notes |
|---------------|-------------------------------|-------------------------|------|-----|-------------------|------------------------|---------|--------|-------|
| MC35FS4500CAE | -40 °C to 150 °C              | 48-pin LQFP exposed pad | 0    | 0   | 0.5 A             | Linear                 | by SPI  | 1      | [1]   |
| MC35FS4500NAE |                               |                         | 0    | 0   | 0.5 A             | Linear                 | by SPI  | 0      |       |
| MC35FS4501CAE |                               |                         | 1    | 0   | 0.5 A             | Linear                 | by SPI  | 1      |       |
| MC35FS4501NAE |                               |                         | 1    | 0   | 0.5 A             | Linear                 | by SPI  | 0      |       |
| MC35FS4502CAE |                               |                         | 0    | 1   | 0.5 A             | Linear                 | by SPI  | 1      |       |
| MC35FS4502NAE |                               |                         | 0    | 1   | 0.5 A             | Linear                 | by SPI  | 0      |       |
| MC35FS4503CAE |                               |                         | 1    | 1   | 0.5 A             | Linear                 | by SPI  | 1      |       |
| MC35FS4503NAE |                               |                         | 1    | 1   | 0.5 A             | Linear                 | by SPI  | 0      |       |

| Part number   | Temperature (T <sub>A</sub> ) | Package                 | FS1B | LDT | VCORE | VCORE type | VKAM on | CAN FD | Notes |
|---------------|-------------------------------|-------------------------|------|-----|-------|------------|---------|--------|-------|
| MC35FS6500CAE | -40 °C to 150 °C              | 48-pin LQFP exposed pad | 0    | 0   | 0.8 A | DC DC      | by SPI  | 1      | [1]   |
| MC35FS6500NAE |                               |                         | 0    | 0   | 0.8 A | DC DC      | by SPI  | 0      |       |
| MC35FS6501CAE |                               |                         | 1    | 0   | 0.8 A | DC DC      | by SPI  | 1      |       |
| MC35FS6501NAE |                               |                         | 1    | 0   | 0.8 A | DC DC      | by SPI  | 0      |       |
| MC35FS6502CAE |                               |                         | 0    | 1   | 0.8 A | DC DC      | by SPI  | 1      |       |
| MC35FS6502NAE |                               |                         | 0    | 1   | 0.8 A | DC DC      | by SPI  | 0      |       |
| MC35FS6503CAE |                               |                         | 1    | 1   | 0.8 A | DC DC      | by SPI  | 1      |       |
| MC35FS6503NAE |                               |                         | 1    | 1   | 0.8 A | DC DC      | by SPI  | 0      |       |
| MC35FS6510CAE |                               |                         | 0    | 0   | 1.5 A | DC DC      | by SPI  | 1      |       |
| MC35FS6510NAE |                               |                         | 0    | 0   | 1.5 A | DC DC      | by SPI  | 0      |       |
| MC35FS6511CAE |                               |                         | 1    | 0   | 1.5 A | DC DC      | by SPI  | 1      |       |
| MC35FS6511NAE |                               |                         | 1    | 0   | 1.5 A | DC DC      | by SPI  | 0      |       |
| MC35FS6512CAE |                               |                         | 0    | 1   | 1.5 A | DC DC      | by SPI  | 1      |       |
| MC35FS6512NAE |                               |                         | 0    | 1   | 1.5 A | DC DC      | by SPI  | 0      |       |
| MC35FS6513CAE |                               |                         | 1    | 1   | 1.5 A | DC DC      | by SPI  | 1      |       |
| MC35FS6513NAE |                               |                         | 1    | 1   | 1.5 A | DC DC      | by SPI  | 0      |       |

[1] To order parts in tape and reel, add the R2 suffix to the part number.

## 6 Block diagram

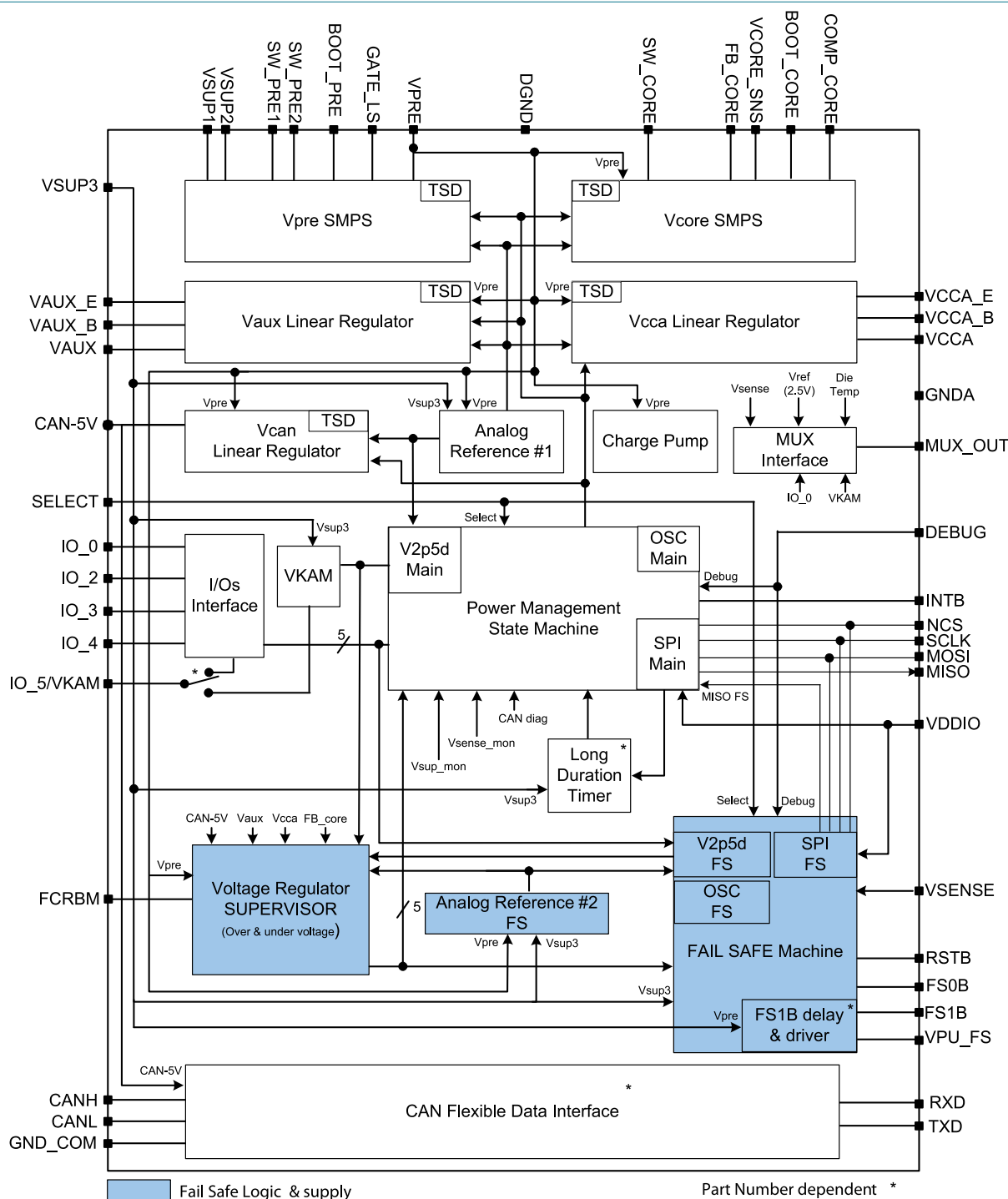


**Figure 3. 35FS4500/35FS6500 simplified internal block diagram**

7 Pinning information

7.1 Pinning

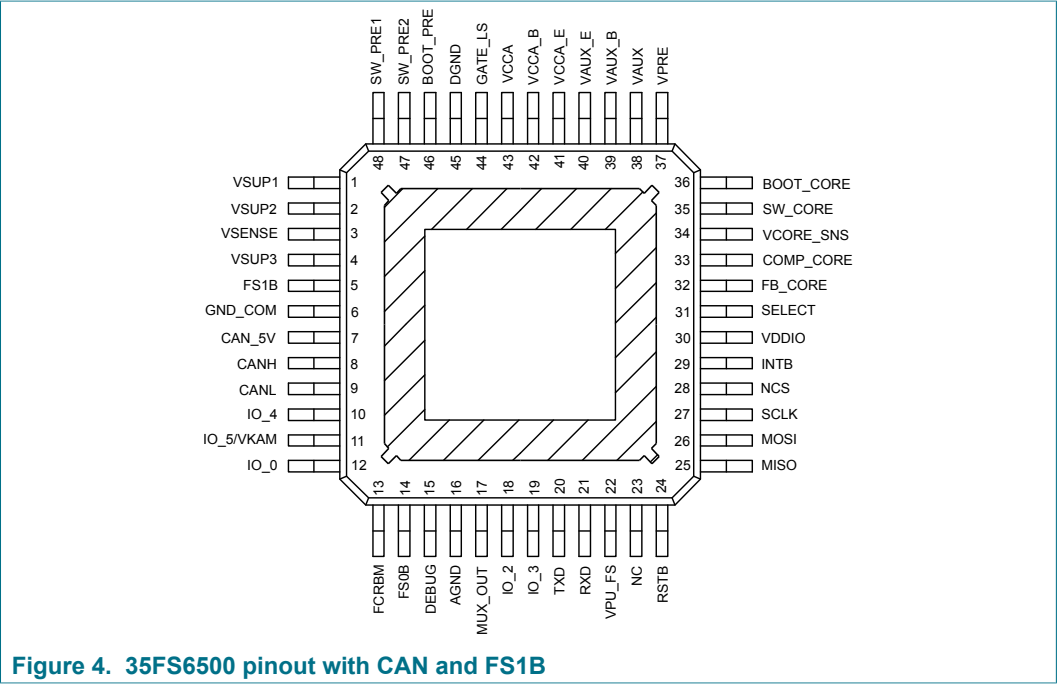


Figure 4. 35FS6500 pinout with CAN and FS1B

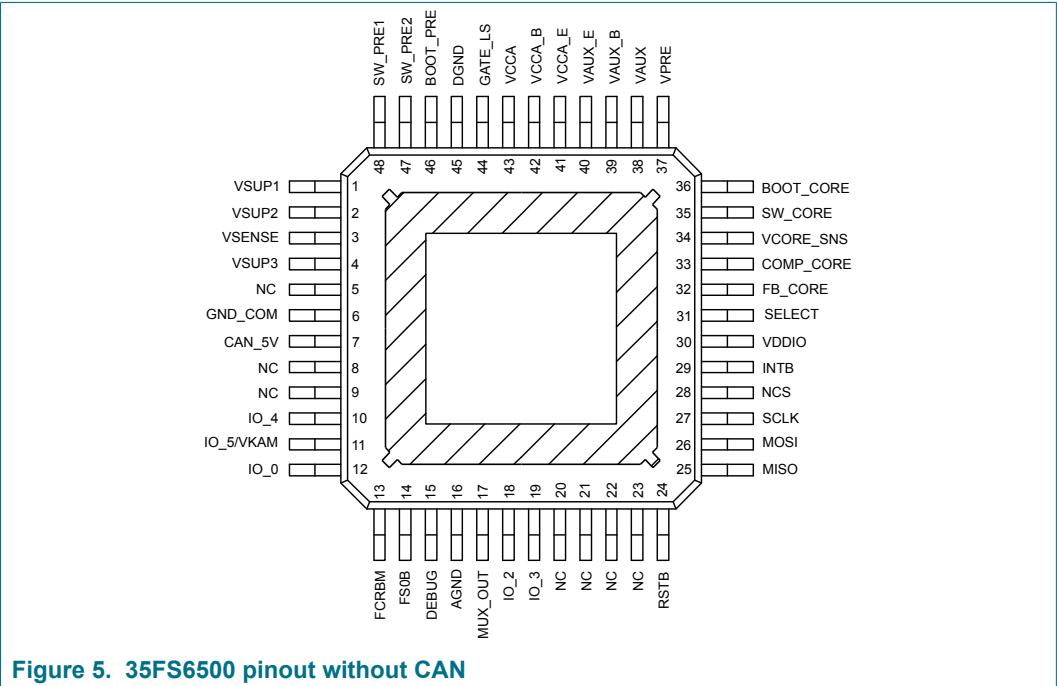


Figure 5. 35FS6500 pinout without CAN

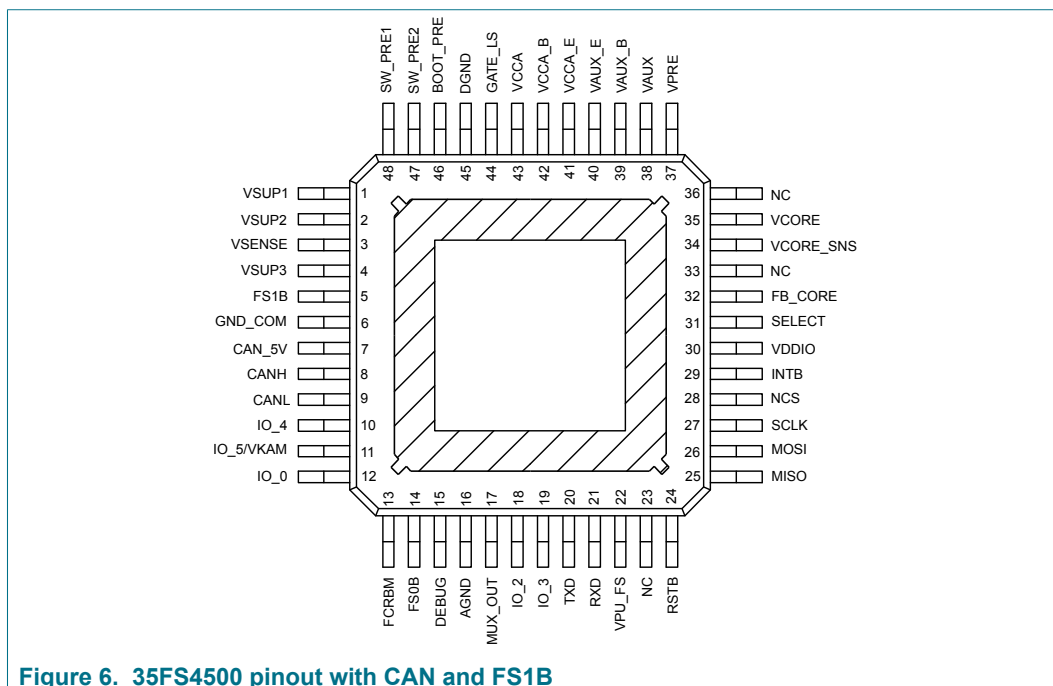


Figure 6. 35FS4500 pinout with CAN and FS1B

## 7.2 Pin description

Table 3. 35FS4500/35FS6500 pin definition

| Pin | Symbol  | Type     | Definition                                                                                                                                                                                                           |
|-----|---------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1   | VSUP1   | A_IN     | Power supply of the device. An external reverse battery protection diode in series is mandatory.                                                                                                                     |
| 2   | VSUP2   | A_IN     | Second power supply. Protected by the external reverse battery protection diode used for VSUP1. VSUP1 and VSUP2 must be connected together externally.                                                               |
| 3   | VSENSE  | A_IN     | Sensing of the battery voltage. Must be connected prior to the reverse battery protection diode.                                                                                                                     |
| 4   | VSUP3   | A_IN     | Third power supply dedicated to the device supply. Protected by the external reverse battery protection diode used for VSUP1. Must be connected between the reverse protection diode and the input PI filter.        |
| 5   | FS1B    | D_OUT    | Second output of the safety block (active low). The pin is asserted low at start-up and when a fault condition is detected, with a configurable delay or duration versus FS0B output terminal. Open drain structure. |
| 6   | GND_COM | GROUND   | Dedicated ground for physical layers                                                                                                                                                                                 |
| 7   | CAN_5V  | A_OUT    | Output voltage for the embedded CAN FD interface                                                                                                                                                                     |
| 8   | CANH    | A_IN/OUT | CAN output high. If CAN function is not used, this pin must be left open.                                                                                                                                            |
| 9   | CANL    | A_IN/OUT | CAN output low. If CAN function is not used, this pin must be left open.                                                                                                                                             |

| Pin      | Symbol    | Type                  | Definition                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|----------|-----------|-----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 10       | IO_4      | D_IN<br>A_OUT         | Can be used as digital input (load dump proof) with wake-up capability or as an output gate driver<br><b>Digital input:</b> Pin status can be read through the SPI. Can be used to monitor error signals from another IC for safety purposes (when used in conjunction with IO_5).<br><b>Wake-up capability:</b> Can be selectable to wake-up on edges or levels.<br><b>Output gate driver:</b> Can drive a logic level low-side NMOS transistor. Controlled by the SPI.                                                                                      |
| 11       | IO_5/VKAM | A_IN<br>D_IN<br>A_OUT | Can be used as digital input with wake-up capability or as an analog output providing keep alive memory supply in low-power mode.<br><b>Analog input:</b> Pin status can be read through the MUX output terminal.<br><b>Digital input:</b> Pin status can be read through the SPI. Can be used to monitor error signals from another IC for safety purposes (when used in conjunction with IO_4).<br><b>Wake-up capability:</b> Can be selectable to wake-up on edges or levels.<br><b>Supply output:</b> Provide keep alive memory supply in low-power mode. |
| 12       | IO_0      | A_IN<br>D_IN          | Can be used as analog or digital input (load dump proof) with wake-up capability (selectable).<br><b>Analog input:</b> Pin status can be read through the MUX output terminal.<br><b>Digital input:</b> Pin status can be read through the SPI.<br><b>Wake-up capability:</b> Can be selectable to wake-up on edges or levels.                                                                                                                                                                                                                                |
| 13       | FCRBM     | A_IN                  | Feedback core resistor bridge monitoring: For safety purposes, this pin is used to monitor the middle point of a redundant resistor bridge connected on V <sub>CORE</sub> (in parallel to the one used to set the V <sub>CORE</sub> voltage). If not used, this pin must be connected directly to FB_CORE.                                                                                                                                                                                                                                                    |
| 14       | FS0B      | D_OUT                 | First output of the safety block (active low). The pin is asserted low at start-up and when a fault condition is detected. Open drain structure.                                                                                                                                                                                                                                                                                                                                                                                                              |
| 15       | DEBUG     | D_IN                  | Debug mode entry input                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 16       | AGND      | GROUND                | Analog ground connection                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 17       | MUX_OUT   | A_OUT                 | Multiplexed output to be connected to a MCU ADC. Selection of the analog parameter is available at MUX-OUT through the SPI.                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 18<br>19 | IO_2:3    | D_IN                  | Digital input pin with wake-up capability (logic level compatible)<br><b>Digital input:</b> Pin status can be read through the SPI. Can be used to monitor FCCU error signals from MCU for safety purposes.<br><b>Wake-up capability:</b> Can be selectable to wake-up on edges or levels.                                                                                                                                                                                                                                                                    |
| 20       | TXD       | D_IN                  | Transceiver input from the MCU which controls the state of the CAN bus. Internal pull-up to VDDIO.<br>If CAN function is not used, this pin must be left open.                                                                                                                                                                                                                                                                                                                                                                                                |
| 21       | RXD       | D_OUT                 | Receiver output which reports the state of the CAN bus to the MCU<br>If CAN function is not used, this pin must be left open.                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 22       | VPU_FS    | A_OUT                 | Pull-up output for FS1B function                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 23       | NC        | N/A                   | Not connected. Pin must be left open.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 24       | RSTB      | D_OUT                 | This output is asserted low when the safety block reports a failure. The main function is to reset the MCU. Reset input voltage is also monitored in order to detect external reset and fault condition. Open drain structure.                                                                                                                                                                                                                                                                                                                                |
| 25       | MISO      | D_OUT                 | SPI bus. Master input slave output                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |

| Pin | Symbol    | Type     | Definition                                                                                                                           |
|-----|-----------|----------|--------------------------------------------------------------------------------------------------------------------------------------|
| 26  | MOSI      | D_IN     | SPI bus. Master output slave input                                                                                                   |
| 27  | SCLK      | D_IN     | SPI Bus. Serial clock                                                                                                                |
| 28  | NCS       | D_IN     | Not chip select (active low)                                                                                                         |
| 29  | INTB      | D_OUT    | This output pin generates a low pulse when an Interrupt condition occurs. Pulse duration is configurable. Internal pull-up to VDDIO. |
| 30  | VDDIO     | A_IN     | Input voltage for MISO output buffer<br>Allows voltage compatibility with MCU I/Os                                                   |
| 31  | SELECT    | D_IN     | Hardware selection pin for VAUX and VCCA output voltages                                                                             |
| 32  | FB_CORE   | A_IN     | VCORE voltage feedback. Input of the error amplifier.                                                                                |
| 33  | COMP_CORE | A_OUT    | Compensation network. Output of the error amplifier.<br>For FS4500 series, this pin must be left open (NC).                          |
| 34  | VCORE_SNS | A_IN     | VCORE input voltage sense                                                                                                            |
| 35  | SW_CORE   | A_OUT    | VCORE output switching point for FS6500 series                                                                                       |
|     | or VCORE  | A_OUT    | VCORE output voltage for FS4500 series                                                                                               |
| 36  | BOOT_CORE | A_IN/OUT | Bootstrap capacitor for VCORE internal NMOS gate drive.<br>For FS4500 series, this pin must be left open (NC).                       |
| 37  | VPRE      | A_IN     | VPRE input voltage sense                                                                                                             |
| 38  | VAUX      | A_OUT    | VAUX output voltage. External PNP ballast transistor. Collector connection                                                           |
| 39  | VAUX_B    | A_OUT    | VAUX voltage regulator. External PNP ballast transistor. Base connection                                                             |
| 40  | VAUX_E    | A_OUT    | VAUX voltage regulator. External PNP ballast transistor. Emitter connection                                                          |
| 41  | VCCA_E    | A_OUT    | VCCA voltage regulator. External PNP ballast transistor. Emitter connection                                                          |
| 42  | VCCA_B    | A_OUT    | VCCA voltage regulator. External PNP ballast transistor. Base connection                                                             |
| 43  | VCCA      | A_OUT    | VCCA output voltage. External PNP ballast transistor. Collector connection                                                           |
| 44  | GATE_LS   | A_OUT    | Low-side MOSFET gate drive for non-inverting buck-boost configuration                                                                |
| 45  | DGND      | GROUND   | Digital ground connection                                                                                                            |
| 46  | BOOT_PRE  | A_IN/OUT | Bootstrap capacitor for the VPRE internal NMOS gate drive                                                                            |
| 47  | SW_PRE2   | A_OUT    | Second pre-regulator output switching point                                                                                          |
| 48  | SW_PRE1   | A_OUT    | First pre-regulator output switching point                                                                                           |

## 8 Maximum ratings

**Table 4. Maximum ratings**

All voltages are with respect to ground, unless otherwise specified. Exceeding these ratings may cause a malfunction or permanent damage to the device.

| Symbol                         | Ratings                                                                             | Value       | Unit | Notes |
|--------------------------------|-------------------------------------------------------------------------------------|-------------|------|-------|
| <b>Electrical ratings</b>      |                                                                                     |             |      |       |
| V <sub>SUP1/2/3</sub>          | DC voltage at power supply pins                                                     | −1.0 to 40  | V    | [1]   |
| V <sub>SENSE</sub>             | DC voltage at battery sense pin (with ext R in series mandatory)                    | −14 to 40   | V    |       |
| V <sub>SW1,2</sub>             | DC voltage at SW_PRE1 and SW_PRE2 Pins                                              | −1.0 to 40  | V    |       |
| V <sub>PRE</sub>               | DC voltage at VPRE Pin                                                              | −0.3 to 8   | V    |       |
| V <sub>GATE_LS</sub>           | DC voltage at Gate_LS pin                                                           | −0.3 to 8   | V    |       |
| V <sub>BOOT_PRE</sub>          | DC voltage at BOOT_PRE pin                                                          | −1.0 to 50  | V    |       |
| V <sub>SW_CORE</sub>           | DC voltage at SW_CORE pin                                                           | −1.0 to 8   | V    |       |
| V <sub>CORE_SNS</sub>          | DC voltage at VCORE_SNS pin                                                         | 0.0 to 8    | V    |       |
| V <sub>BOOT_CORE</sub>         | DC voltage at BOOT_CORE pin                                                         | 0.0 to 15   | V    |       |
| V <sub>FB_CORE</sub>           | DC voltage at FB_CORE pin                                                           | −0.3 to 2.5 | V    |       |
| V <sub>COMP_CORE</sub>         | DC voltage at COMP_CORE pin                                                         | −0.3 to 2.5 | V    |       |
| V <sub>FCRBM</sub>             | DC voltage at FCRBM pin                                                             | −0.3 to 8   | V    |       |
| V <sub>AUX_B,E</sub>           | DC voltage at VAUX_B, VAUX_E pins                                                   | −0.3 to 40  | V    |       |
| V <sub>AUX</sub>               | DC voltage at VAUX pin                                                              | −2.0 to 40  | V    |       |
| V <sub>CCA_B,E</sub>           | DC voltage at VCCA_B, VCCA_E pins                                                   | −0.3 to 8   | V    |       |
| V <sub>CCA</sub>               | DC voltage at VCCA pin                                                              | −0.3 to 8   | V    |       |
| V <sub>DDIO</sub>              | DC voltage at VDDIO pin                                                             | −0.3 to 8   | V    |       |
| V <sub>CAN_5V</sub>            | DC voltage on CAN_5V pin                                                            | −0.3 to 8   | V    |       |
| V <sub>PU_FS</sub>             | DC voltage at VPU_FS pin                                                            | −0.3 to 8   | V    |       |
| V <sub>FSxB</sub>              | DC voltage at FS0B, FS1B pins (with ext R in series mandatory)                      | −0.3 to 40  | V    |       |
| V <sub>DEBUG</sub>             | DC voltage at DEBUG pin                                                             | −0.3 to 40  | V    |       |
| V <sub>IO_0,4</sub>            | DC voltage at IO_0, IO_4 pins (with ext R in series mandatory)                      | −0.3 to 40  | V    |       |
| V <sub>IO_5</sub>              | DC voltage at IO_5 pin                                                              | −0.3 to 20  | V    |       |
| V <sub>KAM</sub>               | DC voltage at VKAM pin                                                              | −0.3 to 8   | V    |       |
| V <sub>DIG</sub>               | DC voltage at INTB, RSTB, MISO, MOSI, NCS, SCLK, MUX_OUT, RXD, TXD, IO_2, IO_3 pins | −0.3 to 8   | V    |       |
| V <sub>SELECT</sub>            | DC voltage at SELECT pin                                                            | −0.3 to 8   | V    |       |
| V <sub>BUS_CAN</sub>           | DC voltage on CANL, CANH pins                                                       | −27 to 40   | V    |       |
| I <sub>I<sub>SENSE</sub></sub> | V <sub>SENSE</sub> maximum current capability                                       | −5.0 to 5.0 | mA   |       |
| I <sub>IO_0, 4, 5</sub>        | IOs maximum current capability (IO_0, IO_4, IO_5)                                   | −5.0 to 5.0 | mA   |       |

| Symbol                    | Ratings                                                               | Value      | Unit | Notes |
|---------------------------|-----------------------------------------------------------------------|------------|------|-------|
| <b>ESD voltage</b>        |                                                                       |            |      |       |
| V <sub>ESD-HBM1</sub>     | Human body model (JESD22/A114) – 100 pF, 1.5 kΩ                       | ±2.0       | kV   | [2]   |
| V <sub>ESD-HBM2</sub>     | • All pins                                                            | ±4.0       | kV   |       |
| V <sub>ESD-HBM3</sub>     | • VSUP1,2,3, VSENSE, VAUX, IO_0,4, FS0B, FS1B, DEBUG                  | ±6.0       | kV   |       |
| V <sub>ESD-CDM1</sub>     | Charge device model (JESD22/C101):                                    | ±500       | V    |       |
| V <sub>ESD-CDM2</sub>     | • All pins                                                            | ±750       | V    |       |
|                           | • Corner pins                                                         |            |      |       |
|                           | <b>System level ESD (gun test)</b>                                    |            |      |       |
|                           | • VSUP1, 2, 3, VSENSE, VAUX, IO_0, 4, 5, FS0B, FS1B                   |            |      |       |
| V <sub>ESD-GUN1</sub>     | 330 Ω/150 pF unpowered according to IEC61000-4-2                      | ±8.0       | kV   |       |
| V <sub>ESD-GUN2</sub>     | 330 Ω/150 pF unpowered according to OEM LIN, CAN, FLEXray Conformance | ±8.0       | kV   |       |
| V <sub>ESD-GUN3</sub>     | 2.0 kΩ/150 pF unpowered according to ISO10605.2008                    | ±8.0       | kV   |       |
| V <sub>ESD-GUN4</sub>     | 2.0 kΩ/330 pF powered according to ISO10605.2008                      | ±8.0       | kV   |       |
|                           | • CANH, CANL                                                          |            |      |       |
| V <sub>ESD-GUN5</sub>     | 330 Ω/150 pF unpowered according to IEC61000-4-2                      | ±15.0      | kV   |       |
| V <sub>ESD-GUN6</sub>     | 330 Ω/150 pF unpowered according to OEM LIN, CAN, FLEXray Conformance | ±12.0      | kV   |       |
| V <sub>ESD-GUN7</sub>     | 2.0 kΩ/150 pF unpowered according to ISO10605.2008                    | ±15.0      | kV   |       |
| V <sub>ESD-GUN8</sub>     | 2.0 kΩ/330 pF powered according to ISO10605.2008                      | ±12.0      | kV   |       |
| <b>Thermal ratings</b>    |                                                                       |            |      |       |
| T <sub>A</sub>            | Ambient temperature                                                   | –40 to 150 | °C   |       |
| T <sub>J</sub>            | Junction temperature                                                  | –40 to 175 | °C   |       |
| T <sub>STG</sub>          | Storage temperature                                                   | –55 to 150 | °C   |       |
| <b>Thermal resistance</b> |                                                                       |            |      |       |
| R <sub>θJA</sub>          | Thermal resistance junction to ambient                                | 30         | °C/W | [3]   |
| R <sub>θJCTOP</sub>       | Thermal resistance junction to case top                               | 23.8       | °C/W | [4]   |
| R <sub>θJCBOTTOM</sub>    | Thermal resistance junction to case bottom                            | 0.9        | °C/W | [5]   |

[1] All VSUPs (V<sub>SUP1/2/3</sub>) must be connected to the same supply

[2] Compared to AGND

[3] Per JEDEC JESD51-6 with the board (JESD51-7) horizontal

[4] Thermal resistance between the die and the case top surface as measured by the cold plate method (MIL SPEC - 883 Method 1012.1).

[5] Thermal resistance between the die and the solder par on the bottom of the packaged based on simulation without any interface resistance.

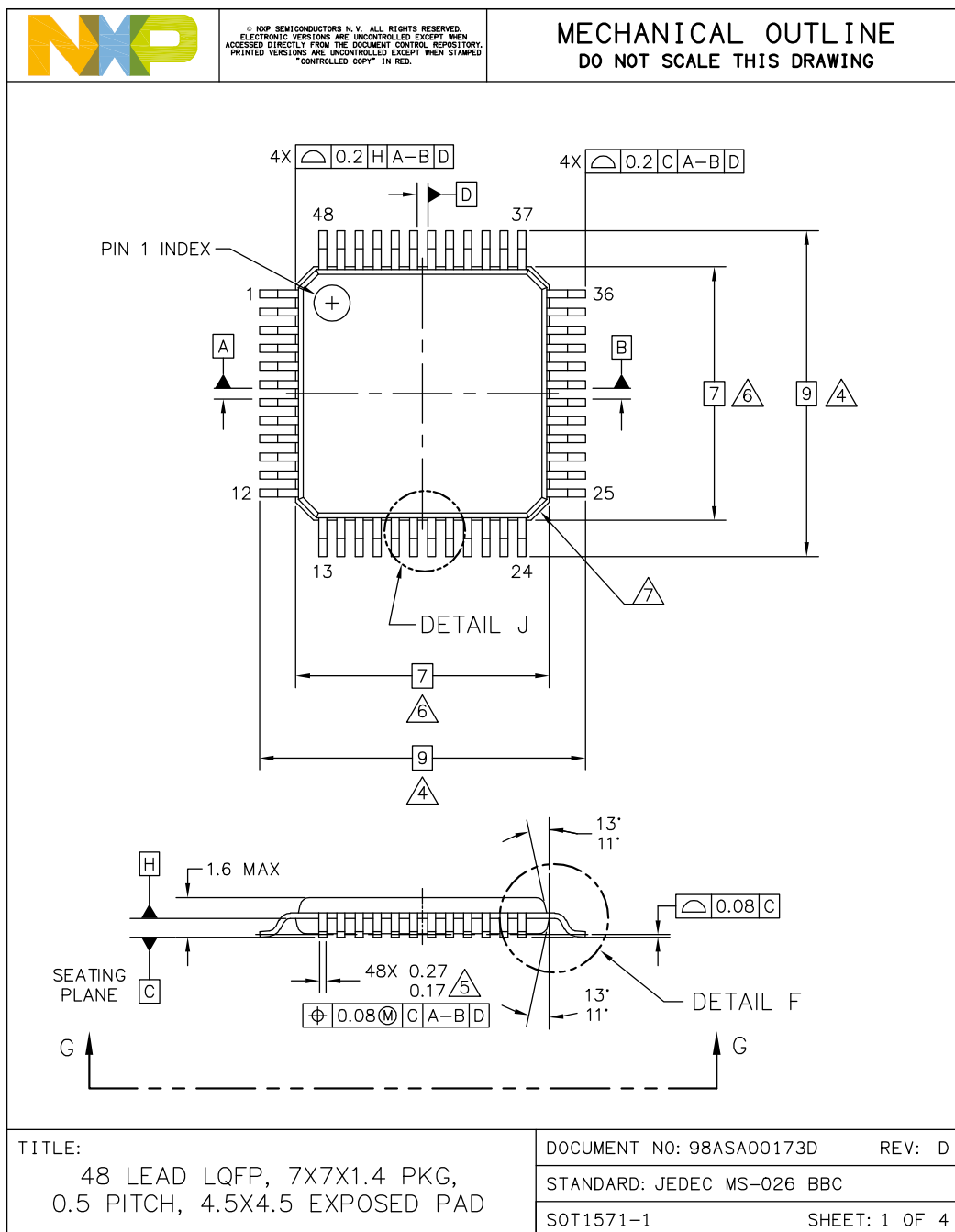
## 9 Packaging

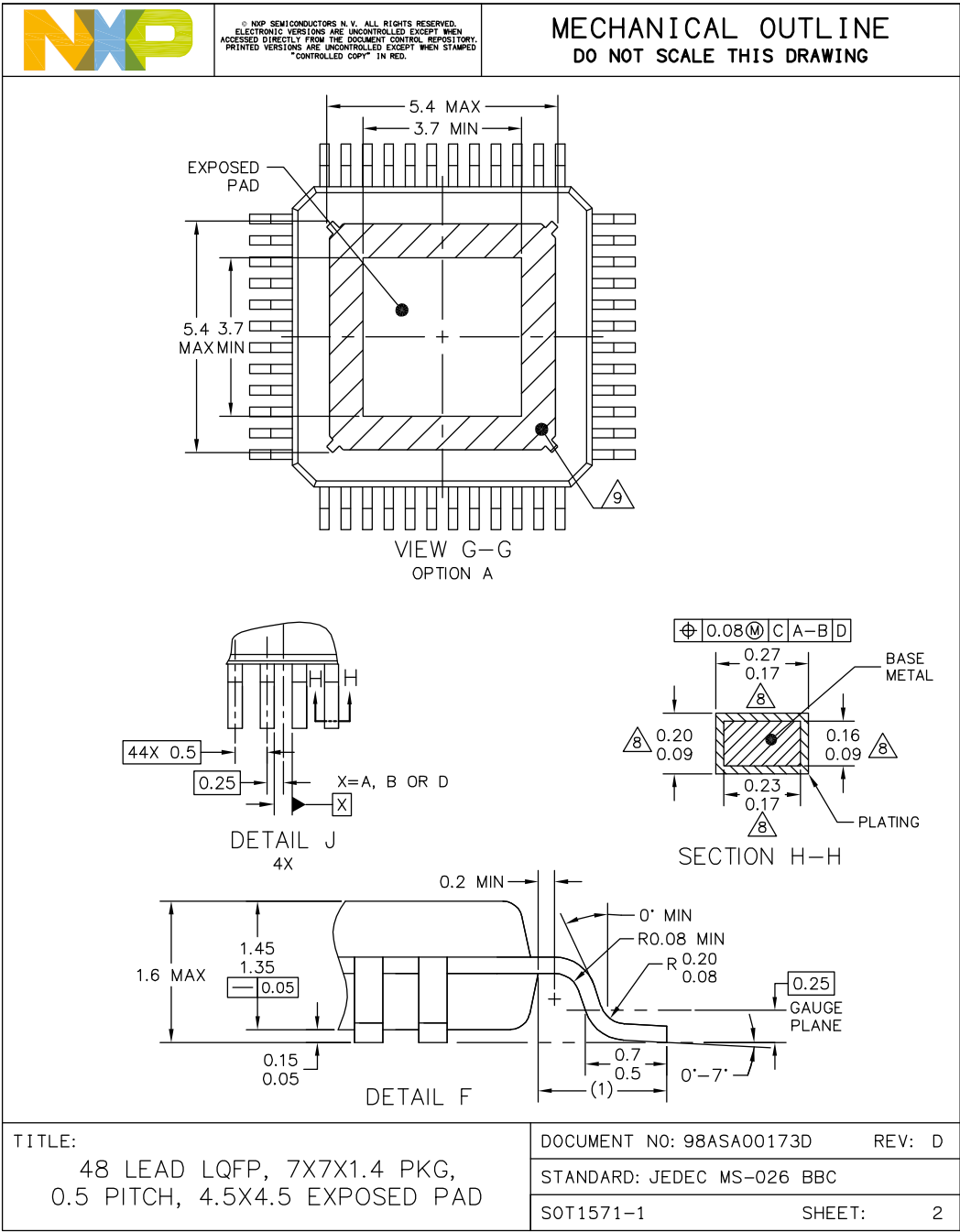
### 9.1 Package mechanical dimensions

Package dimensions are provided in package drawings. To find the most current package outline drawing, go to [www.nxp.com](http://www.nxp.com) and perform a keyword search for the drawing's document number.

### Table 5. Package mechanical dimensions

| Package                                                                            | Suffix | Package outline drawing number |
|------------------------------------------------------------------------------------|--------|--------------------------------|
| 7.0 × 7.0, 48—Pin LQFP exposed pad, with 0.5 mm pitch, and a 4.5 × 4.5 exposed pad | AE     | 98ASA00173D                    |





|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |  |                                                                                                                                                                                                                                                                    |  |                                                                    |  |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--------------------------------------------------------------------|--|
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| <div>NOTES:</div> <div><div>1.</div><div>DIMENSIONS ARE IN MILLIMETERS.</div></div> <div><div>2.</div><div>DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.</div></div> <div><div>3.</div><div>DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.</div></div> <div><div>4.</div><div>DIMENSION TO BE DETERMINED AT SEATING PLANE C.</div></div> <div><div>5.</div><div>THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE UPPER LIMIT BY MORE THAN 0.08MM AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD SHALL NOT BE LESS THAN 0.07MM.</div></div> <div><div>6.</div><div>THIS DIMENSION DOES NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25MM PER SIDE. THIS DIMENSION IS MAXIMUM PLASTIC BODY SIZE DIMENSION INCLUDING MOLD MISMATCH.</div></div> <div><div>7.</div><div>EXACT SHAPE OF EACH CORNER IS OPTIONAL.</div></div> <div><div>8.</div><div>THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.1MM AND 0.25MM FROM THE LEAD TIP.</div></div> <div><div>9.</div><div>HATCHED AREA TO BE KEEP OUT ZONE FOR PCB ROUTING.</div></div> |  |                                                                                                                                                                                                                                                                    |  |                                                                    |  |
| <div>TITLE:</div> <div>48 LEAD LQFP, 7X7X1.4 PKG,<br/>0.5 PITCH, 4.5X4.5 EXPOSED PAD</div>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |  | <div>DOCUMENT NO: 98ASA00173D</div> <div>REV: D</div> <div>STANDARD: JEDEC MS-026 BBC</div> <div>SOT1571-1</div> <div>SHEET: 3</div>                                                                                                                               |  |                                                                    |  |

## 10 References

The following are URLs where you can obtain information on related NXP products and application solutions.

| NXP.com support pages                                        | Description                                                                    | URL                                                                                                                                                                                                         |
|--------------------------------------------------------------|--------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AN5238                                                       | Hardware design and product guidelines                                         | <a href="http://www.nxp.com/AN5238-DOWNLOAD">http://www.nxp.com/AN5238-DOWNLOAD</a>                                                                                                                         |
| AN4388                                                       | Quad flat package (QFP)                                                        | <a href="http://www.nxp.com/files/analog/doc/app_note/AN4388.pdf">http://www.nxp.com/files/analog/doc/app_note/AN4388.pdf</a>                                                                               |
| Power dissipation tool (Excel file)                          |                                                                                | <a href="http://www.nxp.com/files/analog/software_tools/FS6500-FS4500-power-dissipation-calculator.xlsx">http://www.nxp.com/files/analog/software_tools/FS6500-FS4500-power-dissipation-calculator.xlsx</a> |
| V <sub>CORE</sub> compensation network simulation tool (CNC) |                                                                                | Upon demand                                                                                                                                                                                                 |
| FMEDA                                                        | 35FS6500/35FS4500 FMEDA                                                        | Upon demand                                                                                                                                                                                                 |
| 35FS4500-35FS6500SMUG                                        | 35FS4500/35FS6500 Safety Manual – user guide                                   | <a href="https://www.nxp.com/webapp/Download?colCode=35FS4500-35FS6500SMUG">https://www.nxp.com/webapp/Download?colCode=35FS4500-35FS6500SMUG</a>                                                           |
| FS6500-FS4500                                                | Power System Basis Chip with CAN Flexible Data and LIN Transceivers data sheet | <a href="https://www.nxp.com/webapp/Download?colCode=FS6500-FS4500">https://www.nxp.com/webapp/Download?colCode=FS6500-FS4500</a>                                                                           |
| KITFS4503CAEEVM                                              | FS4500 evaluation board with FS1B                                              | <a href="http://www.nxp.com/KITFS4503CAEEVM">http://www.nxp.com/KITFS4503CAEEVM</a>                                                                                                                         |
| KITFS6523CAEEVM                                              | FS6500 evaluation board with FS1B                                              | <a href="http://www.nxp.com/KITFS6523CAEEVM">http://www.nxp.com/KITFS6523CAEEVM</a>                                                                                                                         |
| 35FS4500 product summary page                                |                                                                                | <a href="http://www.nxp.com/FS4500">http://www.nxp.com/FS4500</a>                                                                                                                                           |
| 35FS6500 product summary page                                |                                                                                | <a href="http://www.nxp.com/FS6500">http://www.nxp.com/FS6500</a>                                                                                                                                           |
| Analog power management home page                            |                                                                                | <a href="http://www.nxp.com/products/power-management">http://www.nxp.com/products/power-management</a>                                                                                                     |

## 11 Revision history

Table 6. Revision history

| Document ID                | Release date | Data sheet status               | Change notice | Supersedes |
|----------------------------|--------------|---------------------------------|---------------|------------|
| 35FS4500-35FS6500SDS v.1.0 | 20171215     | Data sheet: advance information | —             | —          |

## 12 Legal information

### 12.1 Data sheet status

| Document status <sup>[1][2]</sup>       | Product status <sup>[3]</sup> | Definition                                                                                                                                                                                           |
|-----------------------------------------|-------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [short] Data sheet: product preview     | Development                   | This document contains certain information on a product under development. NXP reserves the right to change or discontinue this product without notice.                                              |
| [short] Data sheet: advance information | Qualification                 | This document contains information on a new product. Specifications and information herein are subject to change without notice.                                                                     |
| [short] Data sheet: technical data      | Production                    | This document contains the product specification. NXP Semiconductors reserves the right to change the detail specifications as may be required to permit improvements in the design of its products. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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Date of release: 15 December 2017

Document Identifier: 35FS4500-35FS6500SDS